Appl. No. 10/671,303

Amendment dated March 6, 2006

Reply to Notice mailed on February 7, 2006

In the Specification:

Please amend the specification as follows.

Please amend paragraph [0074] on page 29 of the specification as follows:

[0074] In another embodiment according to the present invention, a lamination process is

substituted for the spin coating process in order to deposit the high conductivity inducing

polymer in step 1115. Suitable lamination processes for this purpose are disclosed in U.S. patent

application Ser. No. 10/949,632[[ ]], which claimed priority to Provisional U.S. Patent

Application Ser. No. 60/505,880 filed concurrently herewith and herewith, entitled "Process for

Laminating a Dielectric Layer onto into a Semiconductor," the former of which issued on

January 24, 2006 as U.S. Patent No. 6,989,336. Semiconductor." This patent application is

assigned to E. I. du Pont de Nemours and Company, docket No. CL-2181, and is hereby

incorporated herein by reference in its entirety. It is to be understood that such lamination

processes can be used in substitution for spin coating processes in all of the instances where spin

coating is discussed in this specification.

Please amend paragraph [0111] on page 41 of the specification as follows:

[0111] FIGS. 11-16 as discussed above relate to exemplary and non limiting embodiments of

methods according to the present invention. Other suitable methods for making the exemplary

devices shown in FIGS. 1-10 can also be used. For example, other processes can be used for

2

Appl. No. 10/671,303 Amendment dated March 6, 2006 Reply to Notice mailed on February 7, 2006

Please amend paragraph [0113] bridging pages 42 and 43 of the specification as follows:

[0113] A laser head is provided adjacent to the printer cylinder, aimed to direct laser light onto the cylinder surface through the assembled films. The laser head may, for example, include 200 lasers having a collective beam width of 500 microns, providing a resolution of 2 x 5 microns. The exemplary laser spot size has a length of 5 microns across the head, and a width of 2 microns in the direction of printer cylinder rotation. The laser head includes a lead screw for guiding the laser head over the longitudinal axis of the printer cylinder. In operation of the printer, the cylinder turns at a selected rotation rate per unit time, and the lead screw systematically advances the laser head over the printer cylinder surface in a barber pole fashion. The lasers within the

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4